



Product Change Notification

Change Notification #: 118751-00
Change Title: Intel® Server System R2208WF0ZSR
PCN 118751-00, Product Design,
Gasket implementation on 2.5" tool less carrier
Date of Publication: December 9, 2021

Key Characteristics of the Change:

Product Design

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material*	December 24, 2021
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* Intel appreciates the customer's desire to receive the latest revision of products. However, Intel manages inventory on a first in first out (FIFO) basis at the MM# level. Subsequently, customer requests for a specific revision of material (below the MM#) will not be supported by Intel.

Description of Change to the Customer:

Intel is implementing the following changes on the items included in table products affected below.

- A gasket has been added on each side of the 2.5" tool less carrier (TLC), improving the flow of electricity.



Customer Impact of Change and Recommended Action:

Intel anticipates no impact to customers.

Please contact your local Intel Field Sales Rep if you have any further questions about this change.

Products Affected/Intel Ordering Codes:

Marketing Name	Product Code	MM#	Pre Change TA	Post Change TA
Intel® Server System R2208WF0ZSR, Single	R2208WF0ZSR	986050	K39997-010	K39997-011

PCN Revision History:

Date of Revision:

December 9, 2021

Revision Number:

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Reason:

Originally Published PCN



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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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